	Type	Hits	Search Text	DBs
1	BRS	1	5959363.pn.	USPAT
2	BRS	793	257/787.ccls.	USPAT
3	BRS	441	257/780.ccls.	USPAT
4	BRS	232	257/788.ccls.	USPAT
5	BRS	90	257/789.ccls.	USPAT
6	BRS	91	257/795.ccls.	USPAT
7	BRS	832	257/778.ccls.	USPAT
8	BRS	1764	257/787.ccls.	EPO; JPO; IBM_TDB
9	BRS	390	257/788.ccls.	EPO; JPO; IBM_TDB
10	BRS	174	257/789.ccls.	EPO; JPO; IBM_TDB
11	BRS	93	257/795.ccls.	EPO; JPO; IBM_TDB
12	BRS	942	257/787.ccls.	USPAT; US-PGPUB
13	BRS	433	257/783.ccls.	USPAT; US-PGPUB
14	BRS	267	257/788.ccls.	USPAT; US-PGPUB
15	BRS	60	257/783.ccls. and modulus	USPAT; US-PGPUB
16	BRS	154	257/783.ccls. and coefficient and expansion	USPAT; US-PGPUB
17	BRS	150	(257/783.ccls. and coefficient and expansion) and thermal	USPAT; US-PGPUB
18	BRS	1	(257/783.ccls. and modulus) and pascal	USPAT; US-PGPUB
19	BRS	1	"5199164".PN.	USPAT
20	BRS	1	"4901137".PN.	USPAT
21	BRS	51	(257/783.ccls. and modulus) and (coefficient or expansion)	USPAT; US-PGPUB
22	BRS	7	((257/783.ccls. and modulus) and (coefficient or expansion)) and (shore or hardness)	USPAT; US-PGPUB
23	BRS	4	257/783.ccls. and shore and hardness	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
24	BRS	330	257/783.ccls. and adhesive	USPAT; US-PGPUB
25	BRS	50	(257/783.ccls. and adhesive) and rigid	USPAT; US-PGPUB
26	BRS	14	((257/783.ccls. and adhesive) and rigid) and (CTE or TEC)	USPAT; US-PGPUB
27	BRS	1	5641997.pn.	USPAT; US-PGPUB
28	BRS	1	6223429.pn.	USPAT; US-PGPUB
29	BRS	5400	(chip or die) and adhesive and coefficient and expansion	USPAT; US-PGPUB
30	BRS	125	257/783.ccls. and adhesive and coefficient and expansion	USPAT; US-PGPUB
31	BRS	51	(257/783.ccls. and adhesive and coefficient and expansion) and properties	USPAT; US-PGPUB
32	BRS	60	257/783.ccls. and adhesive	EPO; JPO; IBM_TDB
33	BRS	157	257/783.ccls.	EPO; JPO; IBM_TDB
34	BRS	1764	257/787.ccls.	EPO; JPO; IBM_TDB
35	BRS	1	5679977.pn.	USPAT
36	BRS	1	5852326.pn.	USPAT
37	BRS	1783	257/787.ccls.	EPO; JPO; IBM_TDB
38	BRS	157	257/783.ccls.	EPO; JPO; IBM_TDB
39	BRS	312	257/782.ccls.	USPAT; US-PGPUB
40	BRS	510	257/783.ccls.	USPAT; US-PGPUB
41	BRS	1073	257/787.ccls.	USPAT; US-PGPUB
42	BRS	294	257/788.ccls.	USPAT; US-PGPUB
43	BRS	1	5679977.pn.	USPAT
44	BRS	1	6265782.pn.	USPAT
45	BRS	596	257/783.ccls.	USPAT; US-PGPUB
46	BRS	1254	257/787.ccls.	USPAT; US-PGPUB
47	BRS	60	257/783.ccls. and modulus and coefficient	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
48	BRS	72	257/787.ccls. and modulus and coefficient	USPAT; US-PGPUB
49	BRS	0	(257/783.ccls. and modulus and coefficient) and logic and memory and processor	USPAT; US-PGPUB
50	BRS	0	(257/787.ccls. and modulus and coefficient) and logic and memory and processor	USPAT; US-PGPUB
51	BRS	2	(257/783.ccls. and modulus and coefficient) and logic and memory	USPAT; US-PGPUB
52	BRS	8	(257/787.ccls. and modulus and coefficient) and logic and memory	USPAT; US-PGPUB
53	BRS	268	257/783.ccls. and polyimide	USPAT; US-PGPUB
54	BRS	403	257/787.ccls. and polyimide	USPAT; US-PGPUB
55	BRS	0	(257/783.ccls. and polyimide) and R1 and R2 and R3	USPAT; US-PGPUB
56	BRS	0	(257/787.ccls. and polyimide) and R1 and R2 and R3	USPAT; US-PGPUB
57	BRS	457	polyimide and R1 and R2 and R3	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
58	BRS	6	((polyimide and R1 and R2 and R3) and alkenyl) and modulus	USPAT; US-PGPUB
59	BRS	35	(polyimide and R1 and R2 and R3) and alkenyl	USPAT; US-PGPUB
60	BRS	157	257/783.ccls.	EPO; JPO; IBM_TDB
61	BRS	396	257/788.ccls.	EPO; JPO; IBM_TDB
62	BRS	1783	257/787.ccls.	EPO; JPO; IBM_TDB
63	BRS	352	257/782.ccls.	USPAT; US-PGPUB
64	BRS	324	257/788.ccls.	USPAT; US-PGPUB
65	BRS	1536	257/778.ccls.	USPAT; US-PGPUB
66	BRS	1	"6265782".PN.	USPAT; US-PGPUB
67	BRS	464	257/783.ccls. and adhesive	USPAT; US-PGPUB
68	BRS	6	(257/783.ccls. and adhesive) and epoxide	USPAT; US-PGPUB
69	BRS	1	6395124.pn.	USPAT; US-PGPUB
70	BRS	1	6265782.pn.	USPAT
71	BRS	1	6144107.pn.	USPAT
72	BRS	1	6395124.pn.	USPAT
73	BRS	1	6225418.pn.	USPAT
74	BRS	596	257/783.ccls.	USPAT; US-PGPUB
75	BRS	1	(257/783.ccls. and (multi adj layer) and ceramic) and MLC	USPAT; US-PGPUB
76	BRS	25	257/783.ccls. and (multi adj layer) and ceramic	USPAT; US-PGPUB